FORM PTO-1595 (Rev. 6-93)	08-20		U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office Γ		
8-12-99	10112		Attorney Docket No.: 041501-5359		
To the Assistant Commissioner for Patents: Please record the attached original documents or co	opy thereof.		ATTN: BOX ASSIGNMENT		
1. Name of conveying party(ies):		2. Name and add	lress of receiving party(ies):		
Sun CHOI		Name: LG Semicon Co., Ltd.			
Additional name(s) of conveying party(ies) attached? Yes X No		Internal Address:			
3. Nature of conveyance: X Assignment Merger Security Agreement Change of Name Other		Street Address: 1, Hyangjeong-dong, Heungduk-ku, Cheongju-si, Chungcheongbuk-do, Korea			
		City: State:	Zip:		
Execution Date:June 30, 1999			e(s) & address(es) attached? X No		
4. Application number(s) or patent number(s):					
If this document is being filed together with a no	ew application the e June 30, 1999	execution date of the	e application is:		
A. Patent Application No.(s) B. Patent No.(s)					
Additional numbers attached:YesX	No	1			
5. Name and address of party to whom corre concerning document should be mailed:	espondence	6. Total number	of applications and patents involved: <u>1</u>		
Name:Mr. J. Michael TheszInternal Address:Morgan, Lewis & Bockius LLP Customer No. 09629		7. Total fee (37 C.F.R §3.41): <u>\$40.00</u> X_Enclosed			
		Authorized to be charged to deposit account 50-0310			
Street Address:1800 M Street, N.W.City:WashingtonState: D.C.Zip:20	0036		unt number: 50-0310 ate of page if paying by deposit account		
9. Statement and Signature					
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.					
Name of Person Signing	Signati	ıre	Date		
E/19/1999 NTHAI1 00000282 09372972 Total number of pages including cover sheet, attachments and documents: 2					
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ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

SOLID STATE IMAGE SENSOR DEVICE AND METHOD FOR FABRICATING THE SAME

for which I/WE executed an application for United States Letters Patent concurrently herewith; or filed an application for United States Letters Patent on ________; and

WHEREAS, <u>LG Semicon Co., Ltd.</u>, a corporation of <u>Korea</u>, whose post office address is <u>I Hyangicong-dong, Heungduk-ku, Cheongiu-si, Chungcheongbuk-do, KOREA</u> (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to be issue upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No. ______, filed ______) the filing date and application number of said application when known.

Full Name of Sole or First Assignor Sun CHOI	Assignor's Signature Chon Don	Date June 30 1999		
Address Tongil Villa B-101 231, Kwansan-dong, Tokyang-ku Koyang-si, Kyonggi-do, KOREA		Citizenship Republic of Korea		
Full Name of Second Assignor	Assignor's Signature	Date		
Address		Citizenship		
Names of additional inventors attached [] Yes [X] No				

IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s).